

Fast Recovery Diodes (Stud Version), 12A



FEATURES

- Short reverse recovery time
- Low stored charge
- Wide current range
- Excellent surge capabilities
- Standard JEDEC types
- Stud cathode and stud anode versions
- Fully characterized reverse recovery conditions
- RoHS compliant

TYPICAL APPLICATIONS

- DC power supplies
- Inverters
- Converters
- Choppers
- Ultrasonic systems
- Freewheeling diodes



DO-203AA(DO-4)

PRODUCT SUMMARY

$I_{F(AV)}$	12A
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MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	12FD..	UNIT
$I_{F(AV)}$	$T_C = 100^\circ\text{C}$	12	A
$I_{F(RMS)}$		19	A
I_{FSM}	50 HZ	170	A
	60 HZ	180	
I^2t	50 HZ	145	A^2s
	60 HZ	134	
$I^2\sqrt{t}$		1452	$I^2\sqrt{\text{s}}$
V_{RRM}	Range	200 to 1200	V
t_{rr}		See Recovery Characteristics table	ns
T_J	Range	-65 to 150	$^\circ\text{C}$

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS

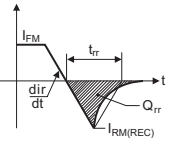
TYPE NUMBER	VOLTAGE CODE	V_{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V_{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	I_{RRM} , MAXIMUM AT $T_J = 25^\circ\text{C}$ μA	I_{RRM} , MAXIMUM AT $T_J = 150^\circ\text{C}$ mA
12FD(R)	02	200	275	10	6.0
	04	400	500		
	06	600	725		
	08	800	950		
	10	1000	1200		
	12	1200	1400		

Note (1) JEDEC registered values

FORWARD CONDUCTION					
PARAMETER	SYMBOL	TEST CONDITIONS		12FD(R)	UNIT
Maximum average forward current at case temperature	$I_{F(AV)}$	180° conduction, half sine wave DC		12 ⁽¹⁾	A
		T_C		100	°C
Maximum RMS forward current	$I_{F(RMS)}$			19	A
Maximum peak, one-cycle non-repetitive surge current	I_{FSM}	t = 10ms	No voltage reapplied	170	A
		t = 8.3ms		180	
		t = 10ms	100% V_{RRM} reapplied	145	
		t = 8.3ms		150 ⁽¹⁾	
Maximum I^2t for fusing	I^2t	t = 10ms	No voltage reapplied	145	A ² s
		t = 8.3ms		134	
		t = 10ms	100% V_{RRM} reapplied	105	
		t = 8.3ms		93	
Maximum I^2/t for fusing	I^2/t	t = 0.1 to 10 ms, no voltage reapplied		1452	A ² √s
Maximum on-state voltage	V_{FM}	$T_J = 25^\circ\text{C}; I_F = 12\text{ A}$		1.4 ⁽¹⁾	V
		$T_C = 100^\circ\text{C}; I_{FM} = 38\text{ A}$		1.5 ⁽¹⁾	

Note (1) JEDEC registered values

RECOVERY CHARACTERISTICS					
PARAMETER	SYMBOL	TEST CONDITIONS	12FD(R)		UNIT
			02 to 06	08 to 12	
Maximum reverse recovery time	t_{rr}	$I_F = 1\text{ A}, I_R = 0.5\text{ A}, I_{RR} = 0.25\text{ A}$ (RG#1 CKT)	200	500	ns
		$T_J = 25^\circ\text{C}, dI_F/dt = 25\text{ A}/\mu\text{s},$ $I_{FM} = \pi \times \text{rated } I_{F(AV)}$	200	500	



THERMAL AND MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	12FD(R)	UNITS
Maximum junction operating temperature range	T_J		- 65 to 150	°C
Maximum storage temperature range	T_{stg}		- 65 to 175	
Maximum thermal resistance, junction to case	R_{thJC}	DC operation	2.0	K/W
Maximum thermal resistance case to heatsink	R_{thCS}	Mounting surface, smooth, flat and greased	0.5	
Allowable mounting torque		Not-lubricated threads	1.5 ⁺⁰ _{-10%} (13)	N · m (lbf · in)
		Lubricated threads	1.2 ⁺⁰ _{-10%} (10)	N · m (lbf · in)
Approximate weight			7	g
			0.25	oz.
Case style		JEDEC	DO-203AA (DO-4)	

ΔR_{thJc} CONDUCTION				
CONDUCTION ANGLE	12FD(R)		TEST CONDUCTIONS	UNITS
	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION		
180°	0.46	0.26	T _J = 150°C	K/W
120°	0.48	0.46		
60°	1.02	1.02		
30°	1.76	1.76		

Note

- The table above shows the increment of thermal resistance R_{thJc} when devices operate at different conduction angles than DC

ORDERING INFORMATION SCHEME	
<p>12 FD R 06 A</p>	<p>Current 12 = 12A</p> <p>Diode type FD = Fast Recovery Diode</p> <p>Polarity R = Reverse None = standard</p> <p>Voltage 06 = 600V 08 = 800V 10 = 1000V 12 = 1200V</p> <p>Trr value A = 200 ns Max. B = 500 ns Max.</p>

Fig.1 Average forward current vs. maximum allowable case temperature.

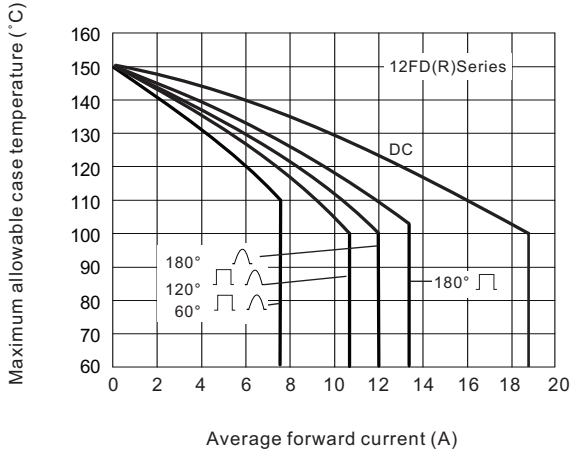
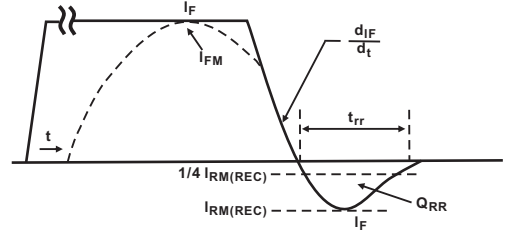


Fig.2 Reverse recovery time test waveform



I_F, I_{FM} = Peak forward current prior to commutation
 $- dI_F/dt$ = Rate of fall of forward current
 $I_{RM(REC)}$ = Peak reverse recovery current
 t_{rr} = Reverse recovery time
 Q_{RR} = Reverse recovered charge

Fig. 3 Current rating nomogram (sinusoidal waveforms)

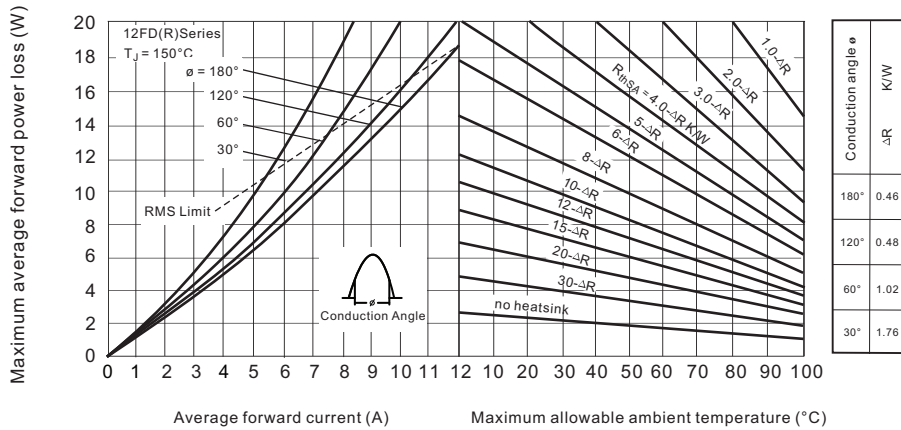


Fig.4 Current rating nomogram (Rectangular Waveforms).

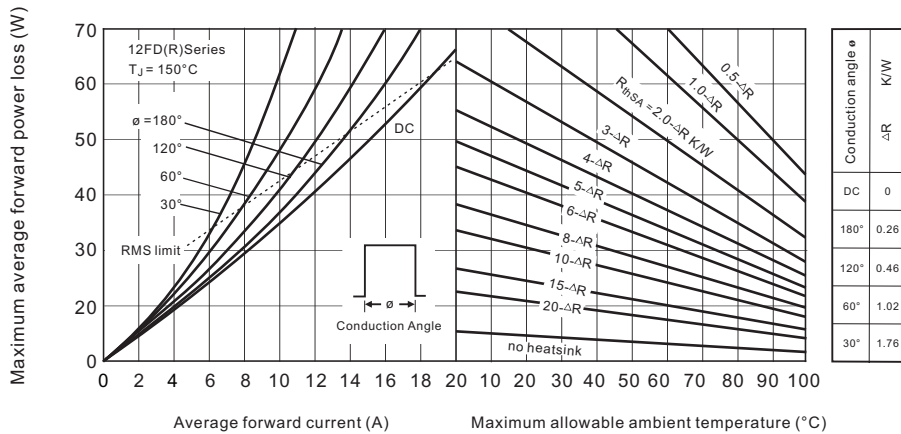


Fig. 5 Maximum forward voltage vs. forward current.

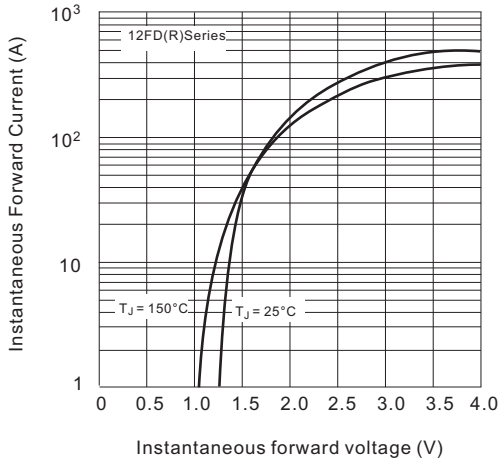


Fig. 6 Maximum high level forward power loss vs. average forward current

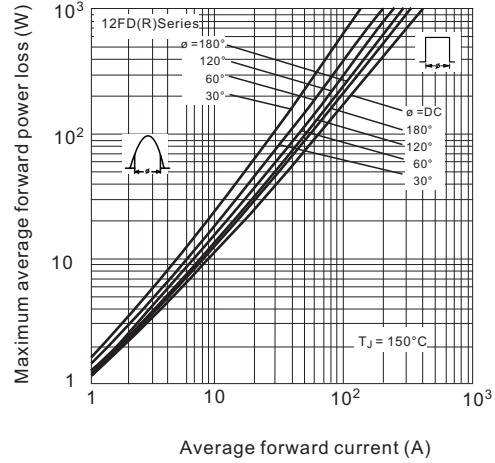


Fig. 7 Typical reverse recovery time vs. rate of fall of forward current.

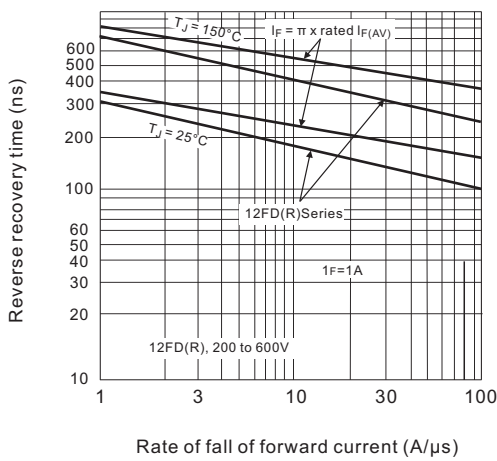


Fig. 8 Typical recovered charge vs. rate of fall of forward current.

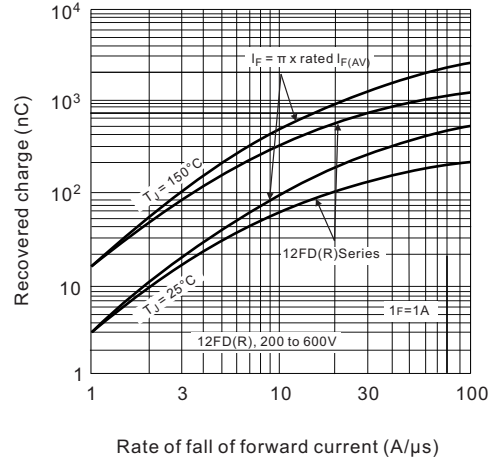


Fig. 9 Typical reverse recovery time vs. rate of fall of forward current.

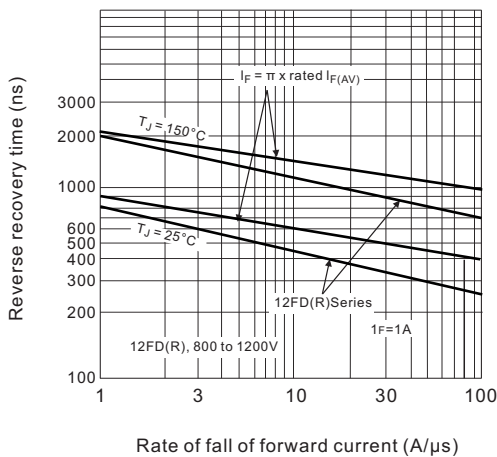


Fig. 10 Typical recovered charge vs. rate of fall of forward current.

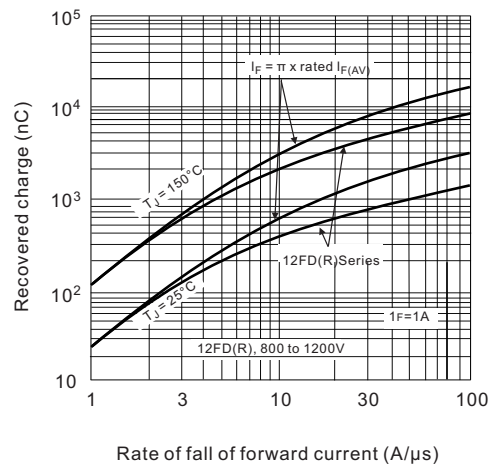


Fig .11 Maximum transient thermal impedance, junction-to-case vs. pulse duration.

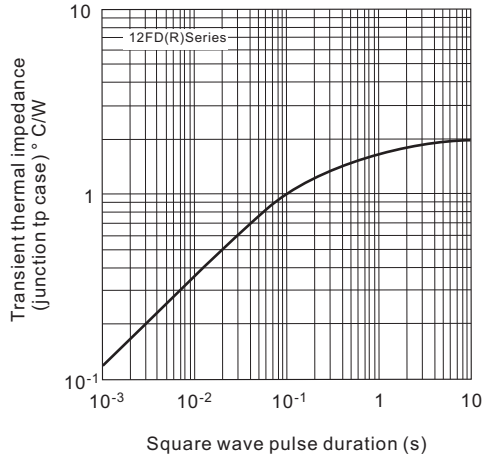
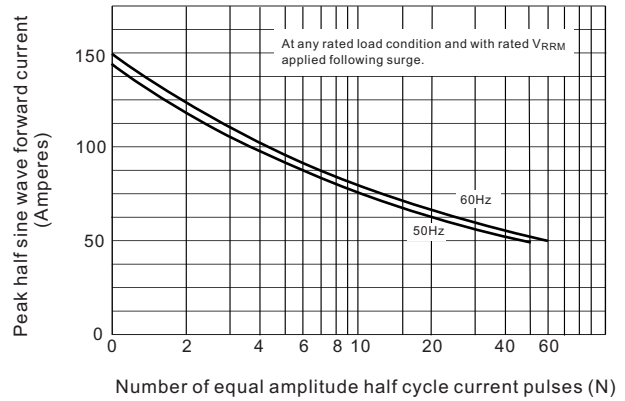


Fig .12 Maximum non-repetitive surge current vs. number of current pulses .



DO-203AA (DO-4)

